

IN THE CLAIMS

SUMMARY:

Please cancel all the old Claims 1 through 58.

Add the new Claims 59 through 76,
as follows:

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DETAILS

What is claimed is:

Claims 1 through 58. (Cancelled)

59. (New) A substrate and attachment pad **assembly** comprising:
a **substrate** having a planar side surface; and
a **group of attachment pads** for constituting **connecting elements**, formed on said planar side surface of said substrate;
at least two or more of said attachment pads, having an **elongated shape** and elongating **in directions** that are substantially **perpendicular** to individual rays, each such ray extending from a **predetermined point** on said planar side surface of said substrate to substantially the **center of each respective said attachment pad; or in other words**,
said at least two or more of said attachment pads being arranged so as to have **their respective short axes in a direction which** extend radially from a **predetermined point** on said planar side surface of said substrate.

60. (New) An assembly according to **claim 59**, wherein said predetermined point on said planar side surface of said substrate is located substantially at **the center of said group** of said attachment pads.

61. (New) An assembly according to **claim 59**, wherein said elongated shape is an **oblong shape**.

62. (New) An assembly according to **claim 59**, wherein said elongated shape is a **rectangular** shape.

63. (New) A substrate and attachment pad **assembly** comprising:
a **substrate** having a planar side surface; and
a **group of attachment pads** formed on said planar side surface of said substrate **for connection with terminals of a mounting article** which is to be mounted on said substrate;
each of said attachment pads, **when observed in a plan view**, having an **elongated shape** and elongating **in a direction** that is substantially **perpendicular** to a respective individual ray, extending from a point which is located substantially at the **center of said group** of said attachment pads to a point near the **center of said attachment pad** with respect to its shape **observed in a plan view; or in other words**,
each of said attachment pads, **when observed in a plan view**, having its **short axis in a direction which** extends radially from a point which is located substantially at the **center of said group** of said attachment pads to a point near the **center of said attachment pad** with respect to its shape **observed in a plan view**.

64. (New) An assembly according to **claim 63**, wherein said substrate is an electronic device, such as a ceramic substrate or a Printed Circuit Board or an IC device.

65. (New) An assembly according to **claim 63**, wherein said **mounting article** is an electronic device, such as an IC device or a Chip or a Package.

66. (New) An assembly according to **claim 63**, wherein said elongated shape is an **oblong shape**.

67. (New) An assembly according to **claim 63**, wherein said elongated shape is a **rectangular** shape.

68. (New) A substrate and attachment pad **assembly** comprising:
a **substrate** having a planar side surface; and
a **group of attachment pads for constituting connecting elements**, formed on said planar side surface of said substrate;
at least two or more of said attachment pads having an **elongated shape** and arranged so as to have **long axes** which extend in **directions** that are substantially **perpendicular** to individual rays, each said ray extending from a **predetermined point** on said planar side surface of said substrate to substantially the **center of each respective said attachment pad; or in other words**,
said at least two or more of said attachment pads being arranged so as to have **short axes** which extend **radially** from a **predetermined point** on said planar side surface of said substrate to substantially the **center of each respective said attachment pad**.

69. (New) An assembly according to **claim 68**, wherein said predetermined point on said planar side surface of said substrate is located substantially at the **center of said group** of said attachment pads.

70. (New) An assembly according to **claim 68**, wherein said elongated shape is an **oblong** shape.

71. (New) An assembly according to **claim 68**, wherein said elongated shape is a **rectangular** shape.

72. (New) A substrate and attachment pad **assembly** comprising:
a **substrate** having a planar side surface; and
a **group of attachment pads** formed on said planar side surface of said substrate **for connection with a mounting article** which is to **be mounted on said substrate**; said attachment pads, when observed in a plan view, having an **elongated shape** and **arranged** so as to have their **long axes** extending in **directions** that are substantially **perpendicular** to individual rays, each said ray extending radially from a point which is located substantially at the **center of said group** of said attachment pads to substantially the **center of each respective said attachment pad; or in other words,**
the short axes of said attachment pads, when observed in a plan view, having **being oriented in radial directions** extending from a point which is located substantially at the **center of said group** of said attachment pads to substantially the **center of each respective said attachment pad**

73. (New) An assembly according to **claim 72**, wherein said elongated shape is an **oblong shape**.

74. (New) An assembly according to **claim 72**, wherein said elongated shape is a **rectangular** shape.

75. (New) An assembly according to **claim 72**, wherein said **substrate** is an **electronic device**, such as a ceramic substrate or a Printed Circuit Board or an IC device.

76. (New) An assembly according to **claim 72**, wherein said **mounting article** is an **electronic device**, such as an IC device or a Chip or a Package.

/Gabe Cherian/